

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	6469855
<b>Application Number:</b>	10537509
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	4531
<b>Title of Invention:</b>	Method for cutting semiconductor substrate
<b>First Named Inventor/Applicant Name:</b>	Fumitsugu Fukuyo
<b>Customer Number:</b>	23973
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<b>Filer Authorized By:</b>	Joseph John Buczynski
<b>Attorney Docket Number:</b>	46884-5388 (211285)
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<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		46884_5388_ids.pdf	179546 864cfd680f584388069888133184d2c357a0926	yes	4

	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Transmittal Letter		1	3	
	Information Disclosure Statement (IDS) Filed (SB/08)		4	4	
Warnings:					
Information:					
2	NPL Documents	46884_5388_EPOA.pdf	249102 0a0ad6766f412be4349e63c311a8a98e530a2eac	no	6
Warnings:					
Information:					
3	Foreign Reference	46884_5388_JP17790.pdf	802651 1786f01e4fbb3b6ccc5b0f6e7b70a1149a311eeff	no	13
Warnings:					
Information:					
4	Foreign Reference	46884_5388_JP046177.pdf	851133 0e6b9b3f40fc173ab191439b49e8509aca0e14e1	no	11
Warnings:					
Information:					
5	Foreign Reference	46884_5388_JP098684.pdf	291178 1ad793f5b42352df494e1dba885aa8f20eb4b0bb	no	6
Warnings:					
Information:					
6	Foreign Reference	46884_5388_JP338468.pdf	1389020 de8e41daec9514018071ccf74b99bc1398f07090	no	18
Warnings:					
Information:					
7	Foreign Reference	46884_5388_JP338636.pdf	1393411 9195b8cbc1192e719f3b35db9a375f399664b9dd	no	20
Warnings:					
Information:					
8	NPL Documents	46884_5388_jpoa.pdf	120946 851a32a892405bc0cef418b517adf97c2a54186e	no	2
Warnings:					
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**If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.**

**National Stage of an International Application under 35 U.S.C. 371**

**If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.**

**New International Application Filed with the USPTO as a Receiving Office**

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